				Pb
		APPROVAL SI	HEET	
	Customer:			
	Part Number:			
	Part No.:	1143601600	00.0001	
	Holder:	OCXO-36		
	Frequency:	16MHz		
	Manufacturer:			
	Date:	2023-03-22		
	Prepared	Checked	Approved	
(For Customer U	se)			
	Acceptable	Non	-Acceptable	

Revision History

No.	Revised Date	Change Content	Approved	Remark
1.0	2023-03-22	Initial Release		

1. Scope

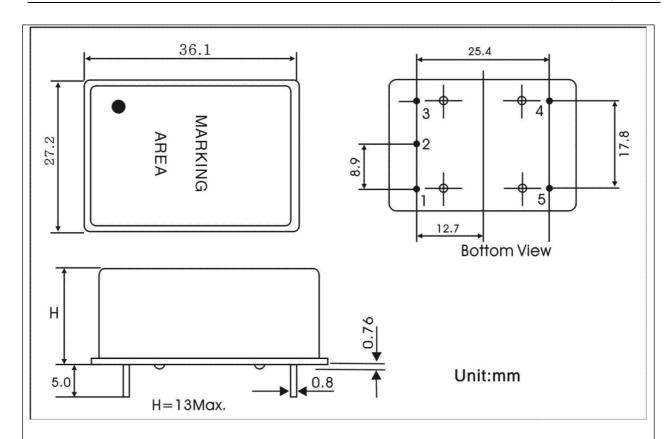
This document describes technical guidelines of product 11436016000.0001

2. Electrical Characteristics

	НС	CMOS OUTPUT OCXO)-36			
PARAMETER	SYMBOL	CONDITIONS	MIN	TYPE	MAX	UNIT
Normal Frequency	F_n	SC	_	16	_	MHz
Absolute maximum r	atings					
Maximum Supply Range	V_{cc}	-	-0.5	_	+5.5	V
Operating Temperature range	TA	-	-40		75	$^{\circ}\! \mathbb{C}$
Storage Temperature			-55		100	$^{\circ}$
Power						
Operating Supply Voltage	V_{cc}		2.97	3. 3	3. 63	V
Turn-On Power	_	Nom Vcc	_	_	4.0	W
Steady state Power	-	Nom Vcc Ta=25℃	-	-	1.4	W
Frequency Stabilit	у			ļ		
Calibration		T _A =25℃			±100	ppb
Freq VS Temperature	TS	-40°C to 75°C (ref to 25°C)			±20	ppb
Freq. VS Voltage		$Vcc=3.3V\pm5\%$			± 2	ppb
Freq. VS Load		Load = 15pF±10%			±2	ppb
Freq VS Time (Aging)	_	Per day			±2	ppb
		Per years			±200	ppb
Warm up time		Time to within 0.1ppm			5	minute
Short Term Stability ADEV(in still air)		@1.0 sec	-	_	0.05	ppb
Electrical Frequen	cy Contr	ol				
Control Voltage Range	V_c	VC Transfer is positive monotonic	0		3	V
Pulling Range			±0.35	± 0.5		ppm

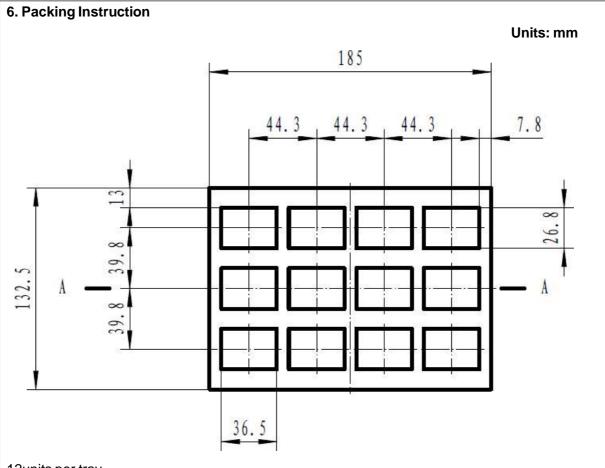
Center voltage				1.5		V
Input impedance (Zi)			100			KΩ
EFC Linearity					10	%
Output parameters						
Output signal		_		HCMOS		_
Output load	CL	Output to ground	13. 5	15pF	16. 5	pF
Amplitude	VOH	Load=15pF	2.97	-	-	V
	VOL	Load=15pF	-	-	0.33	V
Output Duty Cycle	DC	@ 50% of output level	45	-	55	%
Rise & fall Time	-	10%c to 90% Vout	_	-	10	nS
		Offset = 1Hz		-100		
		10Hz		-120		
Phase noise	-	100Hz		-135		dBc/Hz
	-	1KHz		-145		
	-	10KHz		-150		

3.0	3. Construction						
1.	Oscillator enclosure seal:						
	□Seam seal	■resistance weld	□ cold weld				
2.	crystal enclosure m	edium					
	□nitrogen	■vacuum	□dry air				
4 Γ	limension:						



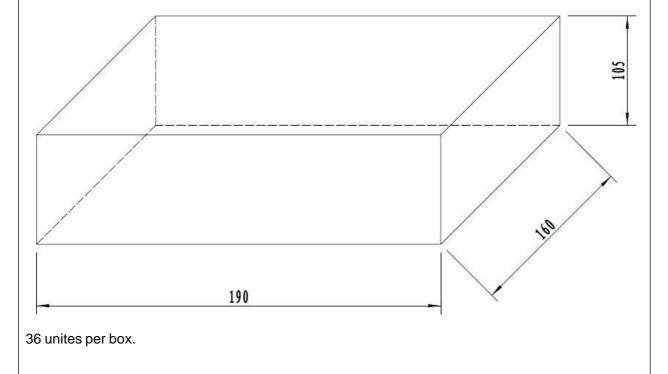
PIN	SYMBOL	FUNCTION
PIN1	Vc	Voltage control
PIN2	Vref/NC	Reference voltage
PIN3	VCC	Supply voltage
PIN4	Output	RF output
PIN5	GND	Ground

5. Marking	
■ Laser Marking	☐ Ink Marking
	g



12units per tray

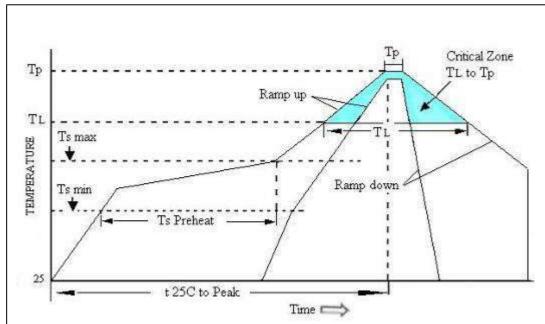
Tray Material: ESD sponge.



	Item	Condition	Specifications
1	Reflow	3X 240°C Peak	ΔF≤±0.2ppm
	Simulation	20 secs max above 240°C	
2	Power Cycle	100 Cycles	ΔF≤±0.2ppm
		-40°C, 30 minutes no power (off) and 30 minutes	
		powered (on)	
		Test product for functionality	
		Continue for another 250 cycles	
		Test product for functionality	
		Intenal visual and mechanical inspection	
7.3	Thermal Shock	Subject samples to temperature extremes of -40 and	ΔF≤±0.2ppm
		+125C, 30 minute soaks at the temperature extremes,	
		10 seconds maximum transition time between	
		extremes. The test duration is 10 Cycles	
		GJB 360A-96 Method 107.	
.4	Mechanical	Subject OCXO to 500 g's, half-sine, pulse width of 1 ms	ΔF≤±0.2ppm
	Shock	for double ovens; 1000 g's , half-sine, pulse width of 1	
		ms for single ovens, five shocks in each of 6 directions	
		of 3 perpendicular planes, for a total of 30 shocks. After	
		shock, check with final test.	
		GJB 360A-96 Method 213	
7.5	Vibration	Vibrate oscillators sinusoidally from 10 Hz to 55 Hz with	ΔF≤±0.2ppm
		a double amplitude of 0.60" and from 55 Hz to 500 Hz	
		with a peak acceleration of 10 g's for 30 minutes in each	
		of three perpendicular directions. Oscillators to be	
		checked with final test after vibration.	
		GB2423.10-1995 (idt IEC 68-2-6:1982) Method Fc.	
.6	Free drop	Drop from 10cm height on 3cm hard wooden board for 6	ΔF≤±0.2ppm
		times	
		GB2423.8-1995 (idt IEC 68-2-32:1990) Method Ed。	
			D 0
7.7	Aging	Bias oscillators at nominal voltage and subject	Per. Spec.
		oscillators to 25C for 1008 hours. Readings are to be	
		taken with oscillator at 25C twice per day. Determine	
		aging (frequency shift post 1008 hours minus initial	

Precondition parts by steaming (over boiling water) for 8 hours OR age the parts at 150C for 16 hours A new uniform coating of solder shall cover a minimum of 95% of the surface being immersed.		frequency). Use the results to predict long-term aging.	
immersed.	8 Solderability		
oHs compliant		hours OR age the parts at 150C for 16 hours	
	All products are	RoHs compliant	
	iii products are	Kons compliant	

9. Reflow Profile



High Temperature Infrared /Convection

Note:Temperature shown are applied to body of device

Ts max to T _L (Ramp-up Rate)	3°C/second max	
Preheat		
Temperature Min(Ts Min)	150℃	
Temperature Typical(Ts Typ)	175℃	
Temperature Max.(Ts Max)	200℃	
Time(ts)	60-180 seconds	
Ram-up Rate(T _L to Tp)	3°C/second Max	
Time Maintained Above:		
Temperature(T _L)	217℃	
Time(T _L)	60-150seconds	
Peak Temperature (Tp)	260°C Max for 10 seconds	
Time within 5°C of actual peak(t _p)	20-40 seconds	
Ramp-down Rate	6°C/seconds Max	
Tune 25°C to Peak Temperature(t)	8 minutes Max	
Moisture Sensitivity Level	Level 1	

High Temperature Manual Soldering

Note:Temperature shown are applied to body of device